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Title of Invention:	Semiconductor integrated circuit and semiconductor substrate of the same
First Named Inventor/Applicant Name:	Hiroaki Ohkubo
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Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement Letter	20702IDS.pdf	65242 5ad3b33d11629acb7ffb25cba23f32498de37d70	no	2

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2	Information Disclosure Statement (IDS) Filed (SB/08)	20702PTO1449.pdf	715986 a5f1aff70b2850ae2f6dcfd65d0f670ca4fe1a8	no	4
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